# Patent Assignment

**SUBMISSION TYPE:** NEW ASSIGNMENT  
**NATURE OF CONVEYANCE:** ASSIGNMENT  

## Conveying Party Data

<table>
<thead>
<tr>
<th>Name</th>
<th>Execution Date</th>
</tr>
</thead>
<tbody>
<tr>
<td>Jae Joon Lee</td>
<td>10/31/2011</td>
</tr>
<tr>
<td>Jae Yeol Choi</td>
<td>03/07/2011</td>
</tr>
<tr>
<td>Hyoong Wook Lim</td>
<td>09/19/2011</td>
</tr>
<tr>
<td>Sung Chul Bae</td>
<td>09/20/2011</td>
</tr>
</tbody>
</table>

## Receiving Party Data

<table>
<thead>
<tr>
<th>Name:</th>
<th>SAMSUNG Electro-Mechanics Co., Ltd.</th>
</tr>
</thead>
<tbody>
<tr>
<td>Street Address:</td>
<td>314 Maetan 3-Dong, Yeongtong-Gu, Suwon,</td>
</tr>
<tr>
<td>City:</td>
<td>Gyeonggi-do</td>
</tr>
<tr>
<td>State/Country:</td>
<td>KOREA, REPUBLIC OF</td>
</tr>
<tr>
<td>Postal Code:</td>
<td>443-743</td>
</tr>
</tbody>
</table>

## Property Numbers Total: 1

<table>
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<tr>
<th>Property Type</th>
<th>Number</th>
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<tbody>
<tr>
<td>Application Number</td>
<td>13480129</td>
</tr>
</tbody>
</table>

## Correspondence Data

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**Attorney Docket Number:** 085946-0251  
**Name of Submitter:** Stephen A. Becker

Total Attachments: 3

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source=0859460251assign#page1.tif  
source=0859460251assign#page2.tif
**RECORDATION FORM COVER SHEET**

**Docket No.: 085946-0251**  
**PATENTS ONLY**

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)
   
   Jae Joon LEE, Jae Yeol CHOI, Hyoung Wook LIM, Sung
   Chul BAE

Additional name(s) of conveying party(ies) attached? Yes ☒ No

2. Name and address of receiving party(ies)
   
   Name: SAMSUNG Electro-Mechanics Co., Ltd.
   
   Internal Address:
   
   Address: 314 Maetan 3-Dong, Yeongtong-gu, Suwon, Gyeonggi-do, Republic of Korea 443-743

3. Nature of Conveyance/Execution Date(s)
   
   Execution Date(s): October 31, 2011; March 7, 2011; September 19, 2011 and September 20, 2011 respectively
   
   ☒ Assignment ☐ Merger
   
   ☐ Security Agreement ☐ Change of Name
   
   ☐ Joint Research Agreement
   
   ☐ Government Interest Assignment
   
   ☐ Executive Order 9424, Confirmatory License

4. Application or patent number(s):
   
   A. Patent Application No(s).
   
   B. Patent No(s).

5. Name and address to whom correspondence concerning document should be mailed:
   
   Name: MCDERMOTT WILL & EMERY LLP
   
   Internal Address:
   
   Street Address: 600 13th Street, N.W.
   
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   Fax Number: 202.756.8087
   
   Email Address: mweipdocket@mwe.com

6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) $40.00
   
   ☐ Authorized to be charged by credit card
   
   ☒ Authorized to be charged to deposit account
   
   ☐ Enclosed
   
   ☐ None required (government interest not affecting title)

8. Payment Information:
   
   a. Credit Card Last 4 Numbers
      
      Expiration Date
      
   b. Deposit Account Number 500417
      
      Authorized User Name

9. Signature.
   
   Stephen A. Becker 26,527

   Name and Registration No. of Person Signing
   
   Signature
   
   Date

   Total number of pages including cover sheet, attachments and documents: 3

May 24, 2012
ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) LEE, Jae Joon
(2) CHOI, Jae Yeol
(3) LIM, Hyoung Wook
(4) BAE, Sung Chul

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG Electro-Mechanics Co., Ltd.
314 Maetan 3-Dong, Yeongtong-Gu,
Suwon, Gyeonggi-Do
Republic of KOREA
Postal Code: 443-743

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

MULTILAYER CERAMIC ELECTRONIC COMPONENT AND METHOD FOR MANUFACTURING THE SAME

(a) for which an application for United States Letters Patent was filed on , and identified by United States Serial No. ; or
(b) for which an application for United States Letters Patent was executed on ,

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS

1) [Signature]
   Name: LEE, Jae Joon
   DATE SIGNED: 2011. 10. 3

2) [Signature]
   Name: CHOI, Jae Yeol
   DATE SIGNED: 2011. 3. 7
3) 
Name: LIM, Hyoung Wook

4) 
Name: BAE, Sung Chul

2011. 9. 19

2011. 9. 19